

LM48411 Boomer[®] Audio Power Amplifier Series

Ultra-Low EMI, Filterless, 2.5W, Stereo, Class D Audio Power Amplifier with E²S

General Description

The LM48411 is a single supply, high efficiency, 2.5W/channel Class D audio amplifier. The LM48411 features National's Enhanced Emissions Suppression (E²S) system, that features a unique patent-pending ultra low EMI, spread spectrum, PWM architecture, that significantly reduces RF emissions while preserving audio quality and efficiency. The E²S system improves battery life, reduces external component count, board area consumption, system cost, and simplifying design.

The LM48411 is designed to meet the demands of mobile phones and other portable communication devices. Operating on a single 5V supply, it is capable of delivering 2.5W/channel of continuous output power to a 4Ω load with less than 10% THD+N. Its flexible power supply requirements allow operation from 2.4V to 5.5V. The wide band spread spectrum architecture of the LM48411 reduces EMI-radiated emissions due to the modulator frequency.

The LM48411 features high efficiency compared to a conventional Class AB amplifier. The E²S system includes an advanced, patent-pending edge rate control (ERC) architecture that further reduce emissions by minimizing the high frequency component of the device output, while maintaining high quality audio reproduction and high efficiency ($\eta = 87\%$ at $V_{DD} = 3.6V$, $P_O = 500mW$). Four gain options are pin selectable through GAIN0 and GAIN1 pins.

The LM48411 features a low-power consumption shutdown mode. Shutdown may be enabled by driving the Shutdown pin to a logic low (GND).

Output short circuit protection prevents the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power up/down and during shutdown. Independent left/right shutdown control maximizes power savings in mixed mono/stereo applications.

Key Specifications

| | |
|--|--------------|
| ■ Efficiency at 3.6V, 500mW into 8Ω speaker | 87% (typ) |
| ■ Efficiency at 3.6V, 100mW into 8Ω speaker | 80% (typ) |
| ■ Efficiency at 5V, 1W into 8Ω speaker | 88% (typ) |
| ■ Quiescent current, 3.6V supply | 4.2mA (typ) |
| ■ Power Output at $V_{DD} = 5V$ $R_L = 4\Omega$, THD $\leq 10\%$ | 2.5W (typ) |
| ■ Power Output at $V_{DD} = 5V$ $R_L = 8\Omega$, THD $\leq 10\%$ | 1.5W (typ) |
| ■ Total shutdown power supply current | 0.01μA (typ) |
| ■ Single supply range | 2.4V to 5.5V |

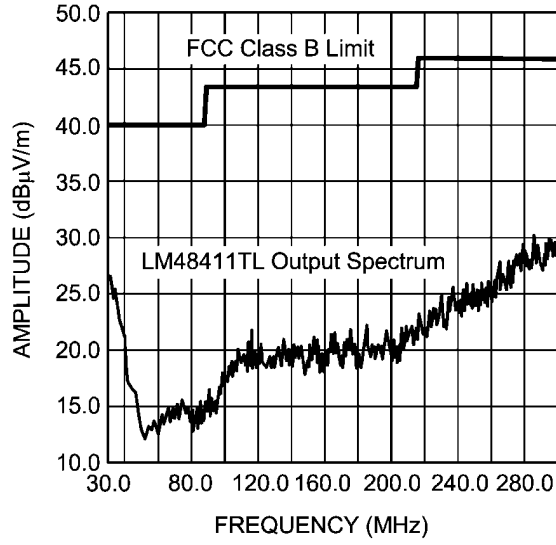
Features

- E²S system reduces EMI preserving Audio Quality and Efficiency
- Output short circuit protection
- Stereo Class D Operation
- No output filter required for inductive loads
- Logic selectable gain
- Independent shutdown control
- Minimum external components
- "Click and pop" suppression circuitry
- Micro-power shutdown mode
- Available in space-saving 0.5mm pitch micro SMD package

Applications

- Mobile phones
- PDAs
- Portable electronic devices

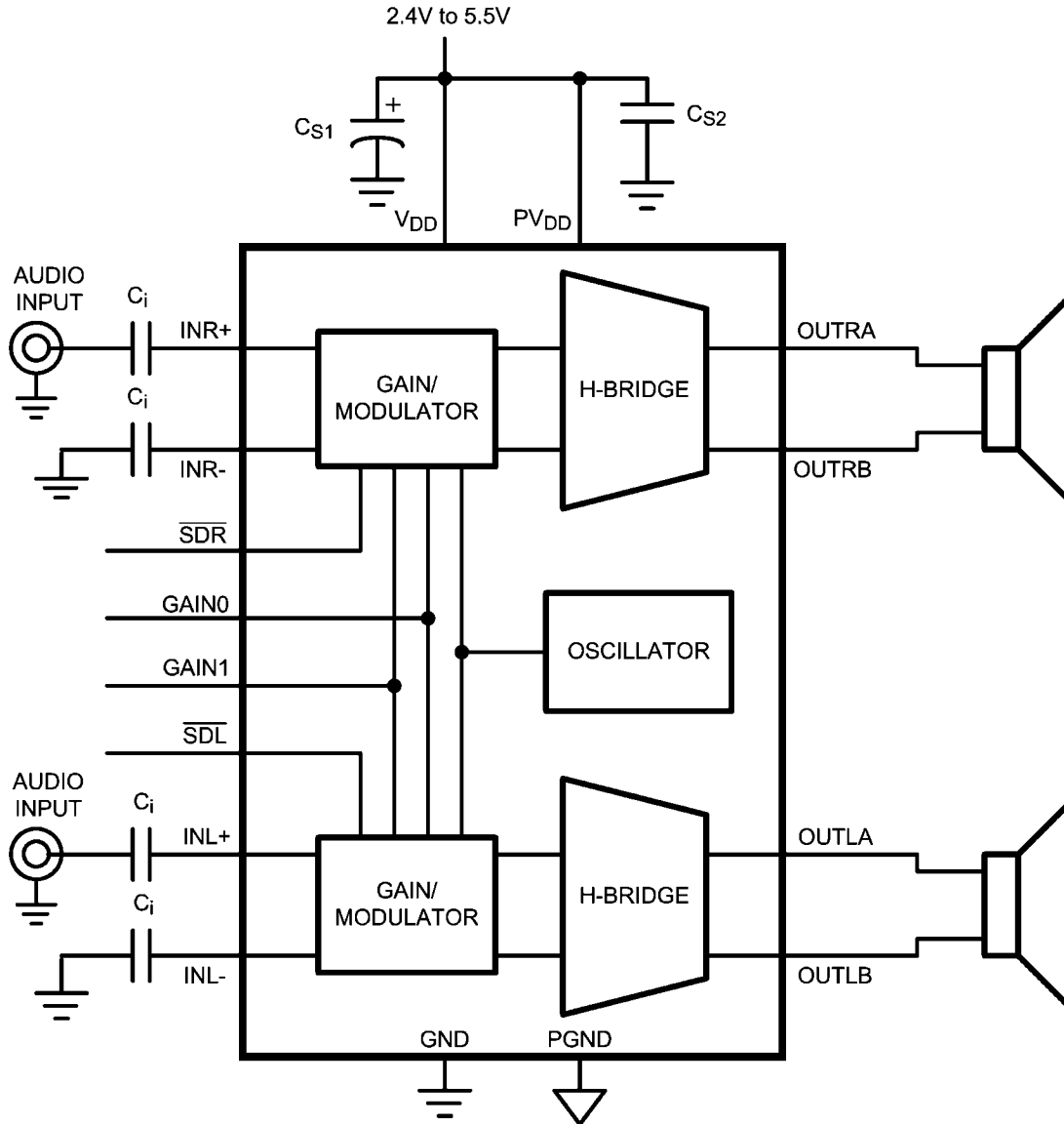
LM48411 RF Emissions



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FIGURE 1. RF Emissions — 3in cable

Typical Application

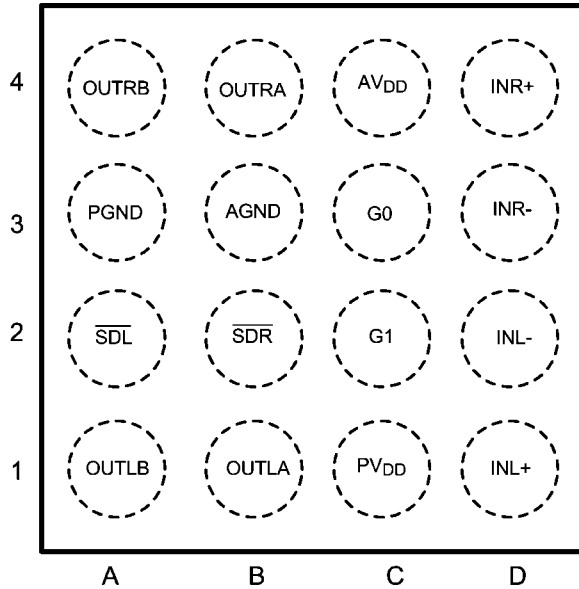


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FIGURE 2. Typical Audio Amplifier Application Circuit

Connection Diagrams

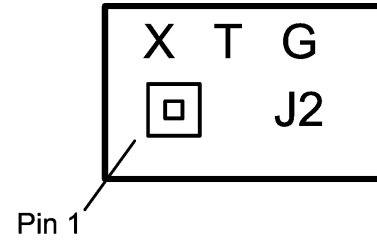
16 Bump micro SMD Package



Top View
Order Number LM48411TL
See NS Package Number TLA16ACA

30009502

micro SMD Marking



Top View
X — Date Code
T — Die Traceability
G — Boomer Family
J2 — LM48411TL

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Pin Descriptions

| Bump | Name | Function |
|------|-------------------------|-----------------------------------|
| A1 | OUTLB | Left Channel output B |
| A2 | $\overline{\text{SDL}}$ | Left channel active low shutdown |
| A3 | PGND | Power GND |
| A4 | OUTRB | Right channel output B |
| B1 | OUTLA | Left channel output A |
| B2 | $\overline{\text{SDR}}$ | Right channel active low shutdown |
| B3 | AGND | Ground |
| B4 | OUTRA | Right channel output A |
| C1 | PV _{DD} | Power V _{DD} |
| C2 | G1 | Gain setting input 1 |
| C3 | G0 | Gain setting input 0 |
| C4 | AV _{DD} | Power supply |
| D1 | INL+ | Non-inverting left channel input |
| D2 | INL- | Inverting left channel input |
| D3 | INR- | Inverting right channel input |
| D4 | INR+ | Non-inverting right channel input |

Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| | |
|-------------------------------------|--|
| Supply Voltage (Note 1) | 6.0V |
| Storage Temperature | -65°C to +150°C |
| Voltage at Any Input Pin | $V_{DD} + 0.3V \geq V \geq GND - 0.3V$ |
| Power Dissipation (Note 3) | Internally Limited |
| ESD Rating, all other pins (Note 4) | 2.0kV |
| ESD Rating (Note 5) | 200V |
| Junction Temperature (T_{JMAX}) | 150°C |

Thermal Resistance

 θ_{JA} (micro SMD)

63.6°C/W

Soldering Information

See AN-1112 "microSMD Wafers Level Chip Scale Package."

Operating Ratings (Notes 1, 2)

Temperature Range

 $T_{MIN} \leq T_A \leq T_{MAX}$ $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$

Supply Voltage

 $2.4V \leq V_{DD} \leq 5.5V$

Electrical Characteristics The following specifications apply for $A_V = 6\text{dB}$, $R_L = 15\mu\text{H} + 8\Omega$, $f = 1\text{kHz}$, unless otherwise specified. Limits apply for $T_A = 25^\circ\text{C}$, $V_{DD} = 3.6\text{V}$.

| Symbol | Parameter | Conditions | LM48411 | | Units (Limits) |
|------------|------------------------------------|--|----------|--------------|---------------------|
| | | | Typical | Limit | |
| | | | (Note 6) | (Notes 7, 8) | |
| I_{VOS} | Differential Output Offset Voltage | $V_I = 0V$, $A_V = 2V/V$, $V_{DD} = 2.4V$ to $5.0V$ | 5 | | mV |
| I_{DD} | Quiescent Power Supply Current | $V_{IN} = 0V$, No Load, $V_{DD} = 5.0V$ | 5.1 | 7.5 | mA (max) |
| | | $V_{IN} = 0V$, No Load, $V_{DD} = 3.6V$ | 4.2 | 6.0 | mA (max) |
| | | $V_{IN} = 0V$, No Load, $V_{DD} = 2.4V$ | 3.0 | 4.5 | mA (max) |
| | | $V_{IN} = 0V$, $R_L = 8\Omega$, $V_{DD} = 5.0V$ | 5.2 | | mA |
| | | $V_{IN} = 0V$, $R_L = 8\Omega$, $V_{DD} = 3.6V$ | 4.2 | | mA |
| | | $V_{IN} = 0V$, $R_L = 8\Omega$, $V_{DD} = 2.4V$ | 3.0 | | mA |
| I_{SD} | Shutdown Current | $V_{SDR} = V_{SDL} = GND$ | 0.01 | 1.0 | μA (max) |
| V_{SDIH} | Shutdown voltage input high | For SDR, SDL | | 1.4 | V (min) |
| V_{SDIL} | Shutdown voltage input low | For SDR, SDL | | 0.4 | V (max) |
| A_V | Gain | GAIN0, GAIN1 = GND $R_L = \infty$ | 6 | 6±0.5 | dB |
| | | GAIN0 = V_{DD} , GAIN1 = GND $R_L = \infty$ | 12 | 12±0.5 | dB |
| | | GAIN0 = GND, GAIN1 = V_{DD} $R_L = \infty$ | 18 | 18±0.5 | dB |
| | | GAIN0, GAIN1 = V_{DD} $R_L = \infty$ | 24 | 24±0.5 | dB |
| R_{IN} | Input Resistance | $A_V = 6\text{dB}$ | 56 | | $k\Omega$ |
| | | $A_V = 12\text{dB}$ | 37.5 | | $k\Omega$ |
| | | $A_V = 18\text{dB}$ | 22.5 | | $k\Omega$ |
| | | $A_V = 24\text{dB}$ | 12.5 | | $k\Omega$ |
| T_{WU} | Wake Up Time | $V_{SDR/SDL} = 0.4V$ | 4.2 | | ms |

| Symbol | Parameter | Conditions | LM48411 | | Units (Limits) |
|------------------|--|--|-------------------|--------------|-------------------|
| | | | Typical | Limit | |
| | | | (Note 6) | (Notes 7, 8) | |
| P _O | Output Power | R _L = 15μH + 4Ω + 15μH THD = 10% (max) f = 1kHz, 22kHz BW V _{DD} = 5V V _{DD} = 3.6V V _{DD} = 2.5V | 2.5 1.2 530 | | W W mW |
| | | R _L = 15μH + 4Ω + 15μH THD = 1% (max) f = 1kHz, 22kHz BW V _{DD} = 5V V _{DD} = 3.6V V _{DD} = 2.5V | 2.0 1.0 430 | | W W mW |
| P _O | Output Power | R _L = 15μH + 8Ω + 15μH THD = 10% (max) f = 1kHz, 22kHz BW V _{DD} = 5V | 1.5 | | W |
| | | V _{DD} = 3.6V | 760 | 600 | mW (min) |
| | | V _{DD} = 2.5V | 330 | | mW |
| | | R _L = 15μH + 8Ω + 15μH THD = 1% (max) f = 1kHz, 22kHz BW V _{DD} = 5V | 1.25 | | W |
| | | V _{DD} = 3.6V | 615 | | mW |
| | | V _{DD} = 2.5V | 270 | | mW |
| | | | | | |
| THD+N | Total Harmonic Distortion + Noise | P _O = 500mW, f = 1kHz, R _L = 8Ω | 0.05 | | % |
| | | P _O = 300mW, f = 1kHz, R _L = 8Ω | 0.03 | | % |
| PSRR | Power Supply Rejection Ratio (Input Referred) | V _{Ripple} = 200mV _{PP} Sine, f _{Ripple} = 217Hz, V _{DD} = 3.6, 5V Inputs to AC GND, C ₁ = 2μF | 78 | | dB |
| | | V _{Ripple} = 200mV _{PP} Sine, f _{Ripple} = 1kHz, V _{DD} = 3.6, 5V Inputs to AC GND, C ₁ = 2μF | 77 | | dB |
| SNR | Signal to Noise Ratio | V _{DD} = 5V, P _O = 1W _{RMS} | 96 | | dB |
| ε _{OUT} | Output Noise (Input Referred) | V _{DD} = 3.6V, A Weighted | 22 | | μV _{RMS} |
| CMRR | Common Mode Rejection Ratio (Input Referred) | V _{DD} = 3.6V, V _{Ripple} = 1V _{PP} Sine f _{Ripple} = 217Hz | 64 | | dB |
| η | Efficiency | V _{DD} = 5V, P _{OUT} = 1W R _L = 8Ω | 88 | | % |
| Xtalk | Crosstalk | P _O = 500mW, f = kHz | 84 | | dB |

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified

Note 2: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower. For the LMxxxxx, see Power Derating curves for additional information.

Note 4: Human body model, applicable std. JESD22-A114C.

Note 5: Machine model, applicable std. JESD22-A115-A.

Note 6: Typical values represent most likely parametric norms at $T_A = +25^\circ\text{C}$, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

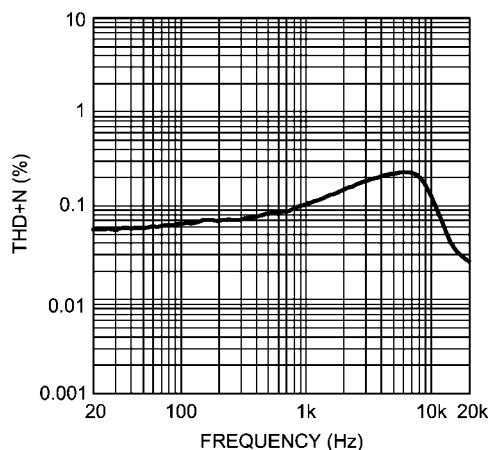
Note 7: Datasheet min/max specification limits are guaranteed by test or statistical analysis.

Note 8: Shutdown current is measured in a normal room environment. Exposure to direct sunlight will increase I_{SD} by a maximum of $2\mu\text{A}$. The Shutdown pin should be driven as close as possible to GND for minimal shutdown current and to V_{DD} for the best THD performance in PLAY mode. See the Application Information section under SHUTDOWN FUNCTION for more information.

Note 9: The performance graphs were taken using the Audio Precision AUX-0025 Switching Amplifier measurement Filter in series with the LC filter on the demo board.

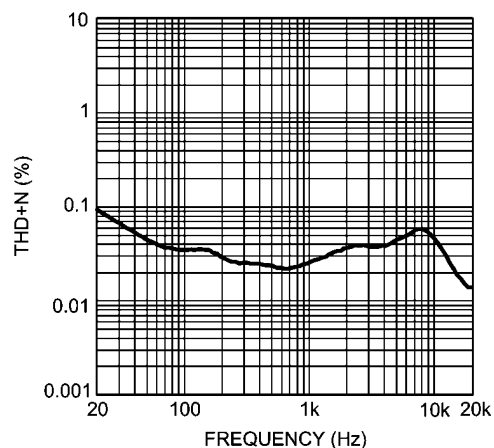
Typical Performance Characteristics

THD+N vs Frequency
 $V_{DD} = 2.5\text{V}$, $R_L = 8\Omega$, $P_O = 100\text{mW/channel}$
 $A_V = 6\text{dB}$



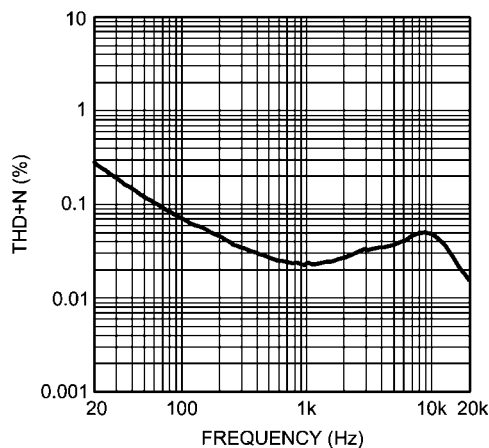
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THD+N vs Frequency
 $V_{DD} = 3.6\text{V}$, $R_L = 8\Omega$, $P_O = 250\text{mW/channel}$
 $A_V = 6\text{dB}$



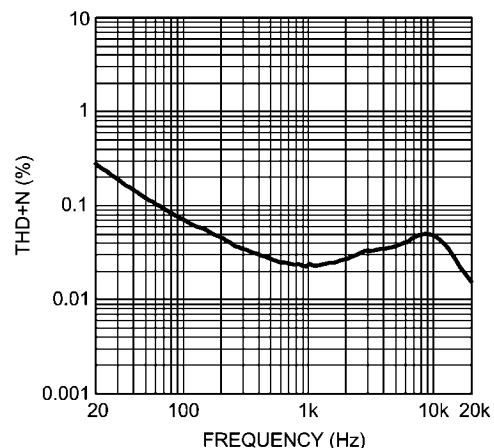
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THD+N vs Frequency
 $V_{DD} = 5.0\text{V}$, $R_L = 8\Omega$, $P_O = 375\text{mW/channel}$
 $A_V = 6\text{dB}$



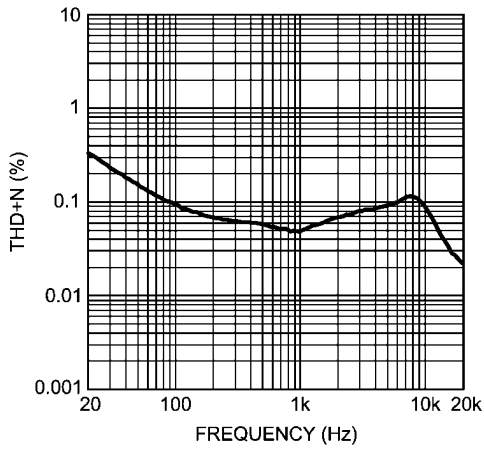
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THD+N vs Frequency
 $V_{DD} = 2.5\text{V}$, $R_L = 4\Omega$, $P_O = 100\text{mW/channel}$
 $A_V = 6\text{dB}$



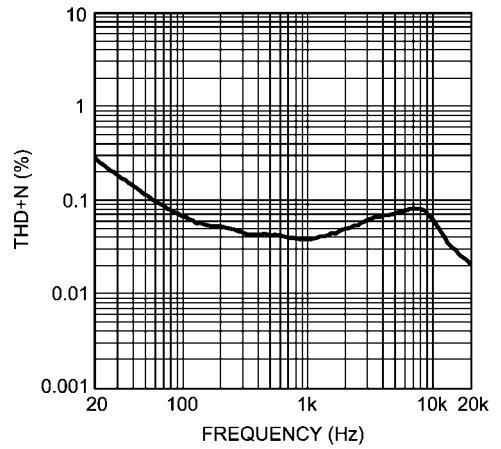
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THD+N vs Frequency
 $V_{DD} = 3.6V, R_L = 4\Omega, P_O = 250mW/channel$
 $A_V = 6dB$



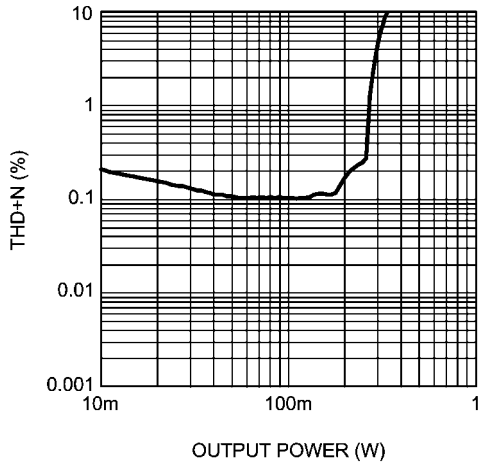
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THD+N vs Frequency
 $V_{DD} = 5.0V, R_L = 4\Omega, P_O = 375mW/channel$
 $A_V = 6dB$



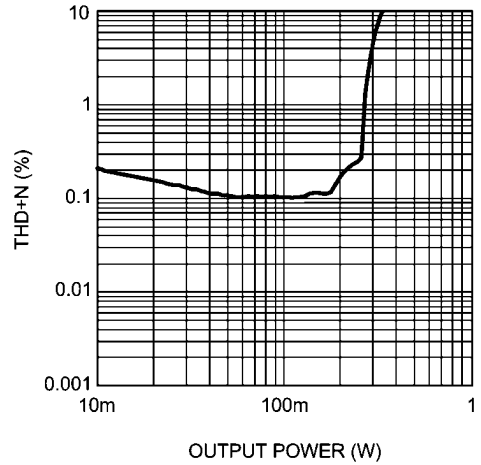
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THD+N vs Output Power
 $V_{DD} = 2.5V, R_L = 8\Omega, A_V = 6dB$



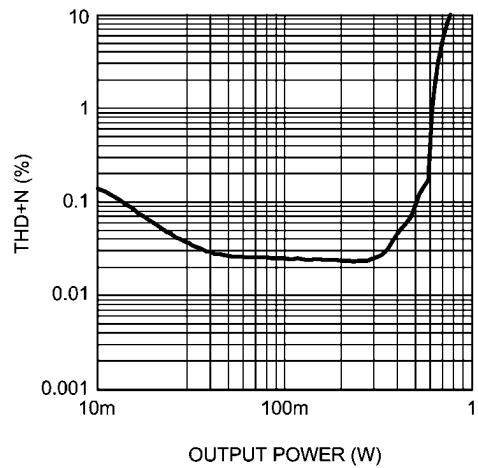
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THD+N vs Output Power
 $V_{DD} = 2.5V, R_L = 8\Omega, A_V = 24dB$



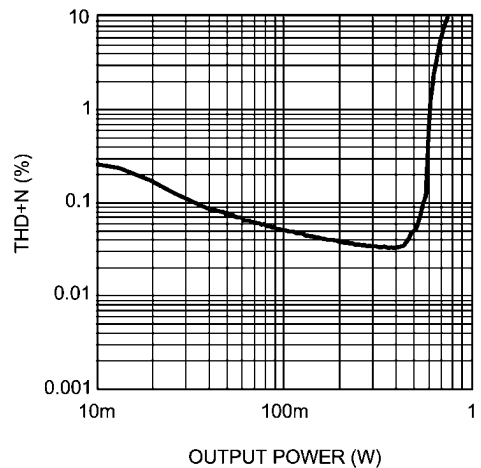
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THD+N vs Output Power
 $V_{DD} = 3.6V, R_L = 8\Omega, A_V = 6dB$

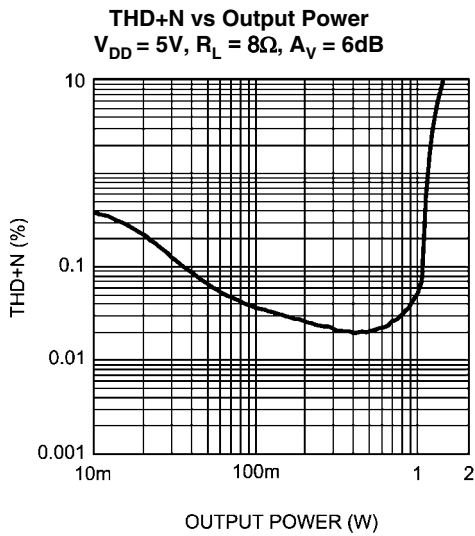


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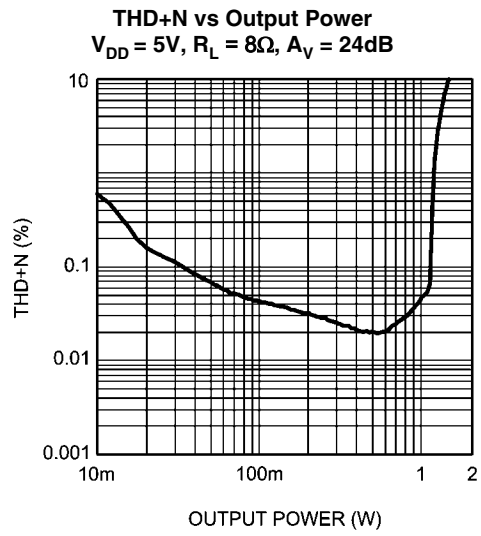
THD+N vs Output Power
 $V_{DD} = 3.6V, R_L = 8\Omega, A_V = 24dB$



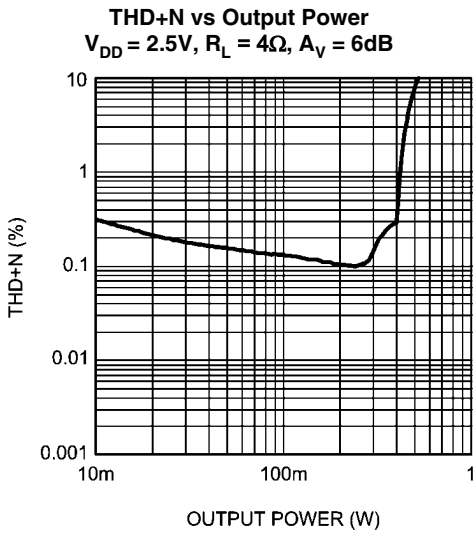
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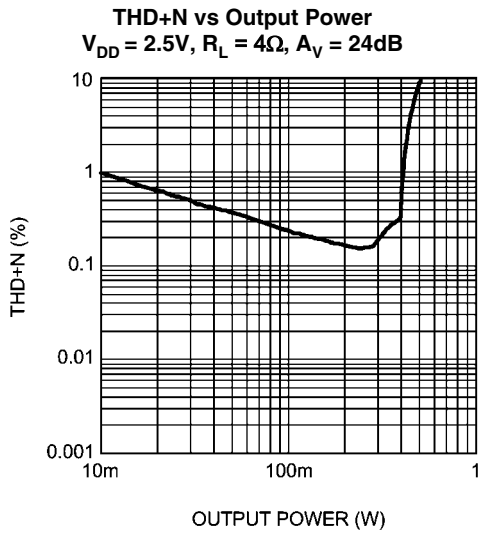
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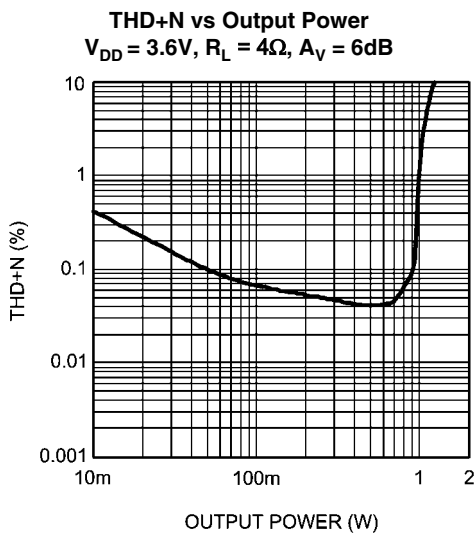
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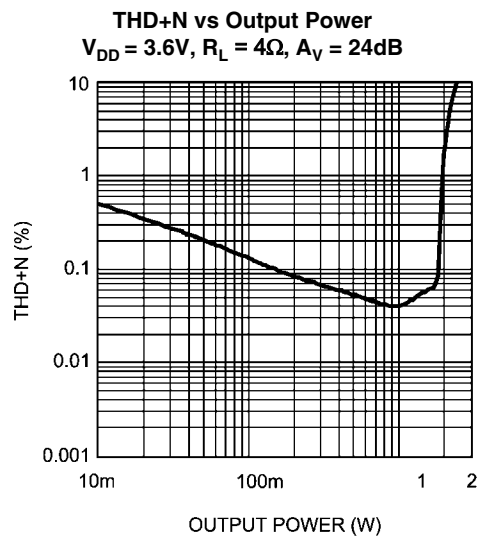
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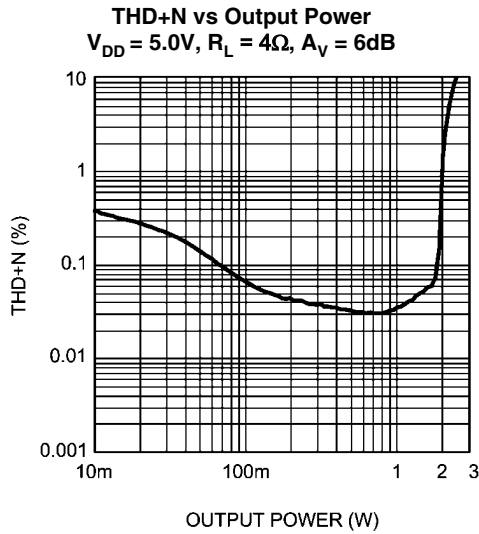
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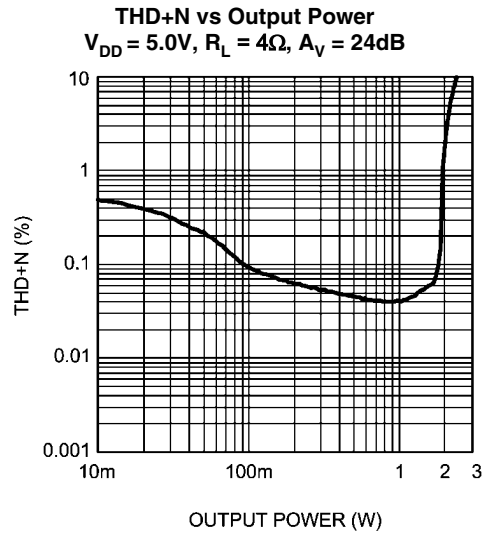
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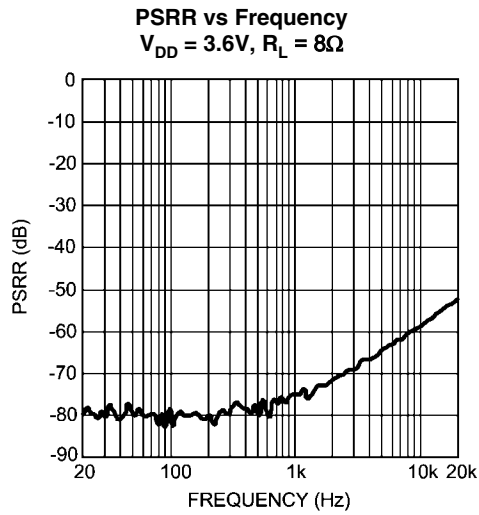
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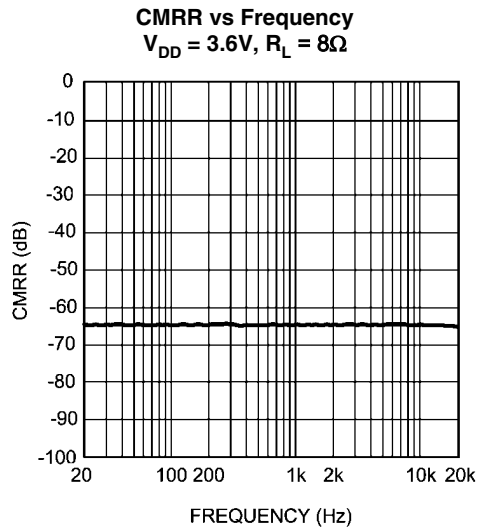
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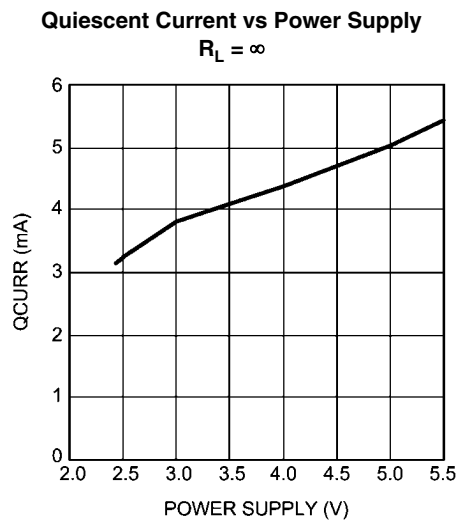
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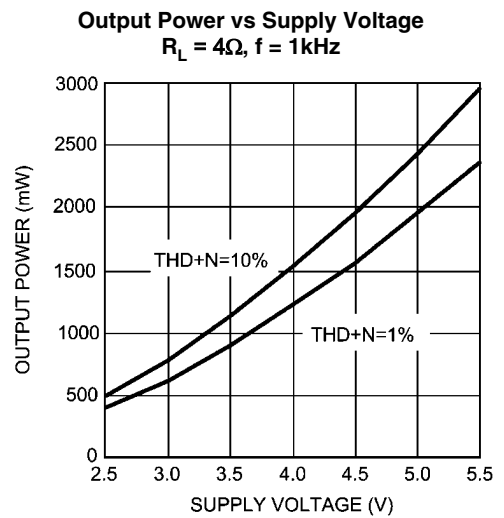
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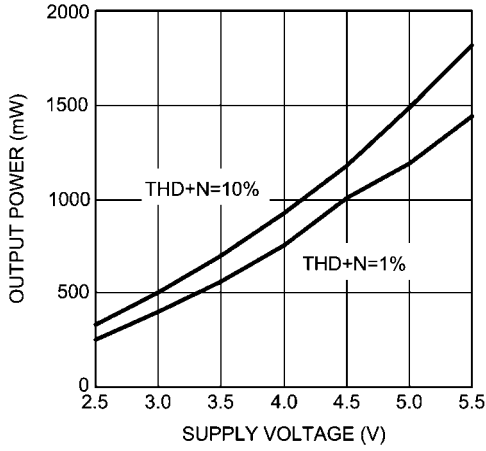


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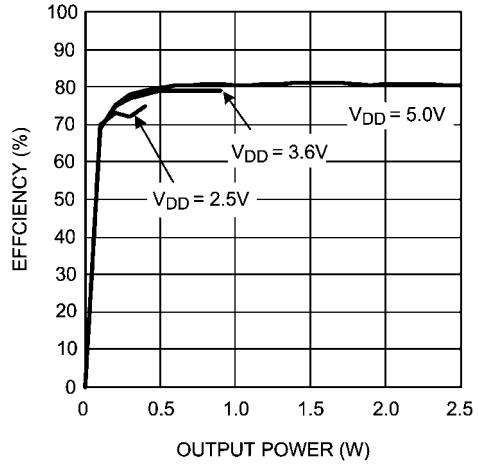
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Output Power vs Supply Voltage
 $R_L = 8\Omega, f = 1\text{kHz}$



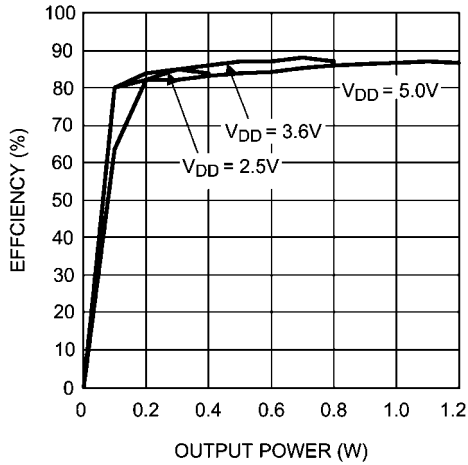
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Efficiency vs Output Power
 $R_L = 4\Omega$



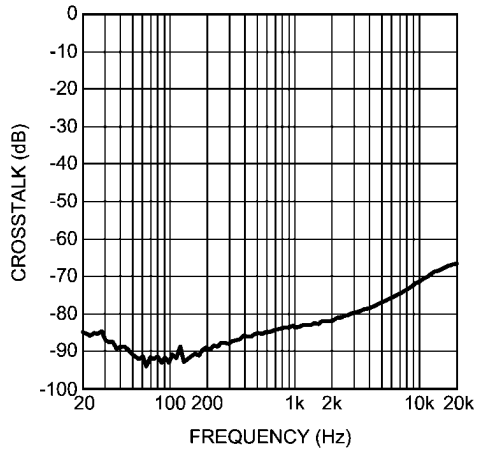
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Efficiency vs Output Power
 $R_L = 8\Omega$



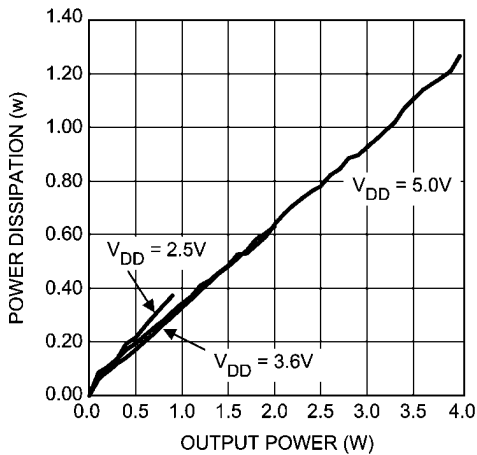
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Crosstalk vs Frequency
 $V_{DD} = 3.6\text{V}, R_L = 8\Omega$



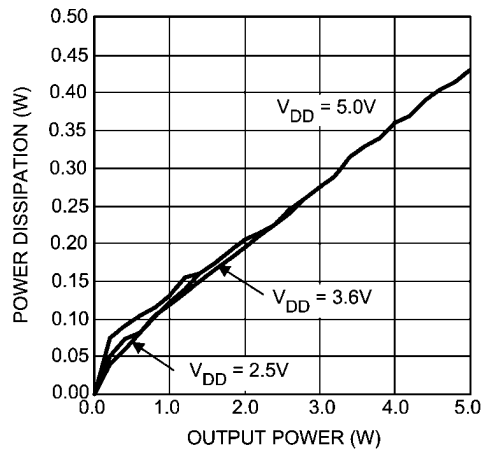
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Power Dissipation vs Output Power
 $R_L = 4\Omega$



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Power Dissipation vs Output Power
 $R_L = 8\Omega$



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External Components Description

(Figure 2)

| Components | | Functional Description |
|------------|-------|---|
| 1. | C_S | Supply bypass capacitor which provides power supply filtering. Refer to the Power Supply Bypassing section for information concerning proper placement and selection of the supply bypass capacitor. |
| 2. | C_I | Input AC coupling capacitor which blocks the DC voltage at the amplifier's input terminals. |

Application Information

GENERAL AMPLIFIER FUNCTION

The LM48411 features a filterless modulation scheme. The differential outputs of the device switch at 300kHz from V_{DD} to GND. When there is no input signal applied, the two outputs (V_{O1} and V_{O2}) switch with a 50% duty cycle, with both outputs in phase. Because the outputs of the LM48411 are differential, the two signals cancel each other. This results in no net voltage across the speaker, thus there is no load current during an idle state, conserving power.

With an input signal applied, the duty cycle (pulse width) of the LM48411 outputs changes. For increasing output voltages, the duty cycle of V_{O1} increases, while the duty cycle of V_{O2} decreases. For decreasing output voltages, the converse occurs, the duty cycle of V_{O2} increases while the duty cycle of V_{O1} decreases. The difference between the two pulse widths yields the differential output voltage.

SPREAD SPECTRUM MODULATION

The LM48411 features a filterless spread spectrum modulation scheme that eliminates the need for output filters, ferrite beads or chokes. The switching frequency varies by $\pm 30\%$ about a 300kHz center frequency, reducing the wideband spectral content, improving EMI emissions radiated by the speaker and associated cables and traces. Where a fixed frequency class D exhibits large amounts of spectral energy at multiples of the switching frequency, the spread spectrum architecture of the LM48411 spreads that energy over a larger bandwidth. The cycle-to-cycle variation of the switching period does not affect the audio reproduction of efficiency.

ENHANCED EMISSIONS SUPPRESSION SYSTEM (E²S)

The LM48411 features National's patent-pending E²S system that reduces EMI, while maintaining high quality audio reproduction and efficiency. The E²S system features a synchronizable oscillator with selectable spread spectrum, and advanced edge rate control (ERC). The LM48411 ERC greatly reduces the high frequency components of the output square waves by controlling the output rise and fall times, slowing the transitions to reduce RF emissions, while maximizing THD+N and efficiency performance.

POWER DISSIPATION AND EFFICIENCY

In general terms, efficiency is considered to be the ratio of useful work output divided by the total energy required to produce it with the difference being the power dissipated, typically, in the IC. The key here is "useful" work. For audio systems, the energy delivered in the audible bands is considered useful including the distortion products of the input signal. Sub-sonic (DC) and super-sonic components (>22kHz) are not useful. The difference between the power flowing from the power supply and the audio band power being transduced is dissipated in the LM48411 and in the transducer load. The amount of power dissipation in the LM48411 is very low. This is because the ON resistance of the switches used to form the output waveforms is typically less than 0.25Ω . This leaves only the transducer load as a potential "sink" for the small excess of input power over audio band output power. The LM48411 dissipates only a fraction of the excess power requiring no additional PCB area or copper plane to act as a heat sink.

DIFFERENTIAL AMPLIFIER EXPLANATION

As logic supply voltages continue to shrink, designers are increasingly turning to differential analog signal handling to preserve signal to noise ratios with restricted voltage swing. The LM48411 is a fully differential amplifier that features differential input and output stages. A differential amplifier amplifies the difference between the two input signals. Traditional audio power amplifiers have typically offered only single-ended inputs resulting in a 6dB reduction in signal to noise ratio relative to differential inputs. The LM48411 also offers the possibility of DC input coupling which eliminates the two external AC coupling, DC blocking capacitors. The LM48411 can be used, however, as a single ended input amplifier while still retaining its fully differential benefits. In fact, completely unrelated signals may be placed on the input pins. The LM48411 simply amplifies the difference between the signals. A major benefit of a differential amplifier is the improved common mode rejection ratio (CMRR) over single input amplifiers. The common-mode rejection characteristic of the differential amplifier reduces sensitivity to ground offset related noise injection, especially important in high noise applications.

PCB LAYOUT CONSIDERATIONS

As output power increases, interconnect resistance (PCB traces and wires) between the amplifier, load and power supply create a voltage drop. The voltage loss on the traces between the LM48411 and the load results in lower output power and decreased efficiency. Higher trace resistance between the supply and the LM48411 has the same effect as a poorly regulated supply, increased ripple on the supply line also reducing the peak output power. The effects of residual trace resistance increases as output current increases due to higher output power, decreased load impedance or both. To maintain the highest output voltage swing and corresponding peak output power, the PCB traces that connect the output pins to the load and the supply pins to the power supply should be as wide as possible to minimize trace resistance.

The use of power and ground planes will give the best THD +N performance. While reducing trace resistance, the use of power planes also creates parasitic capacitors that help to filter the power supply line.

The inductive nature of the transducer load can also result in overshoot on one or both edges, clamped by the parasitic diodes to GND and V_{DD} in each case. From an EMI standpoint, this is an aggressive waveform that can radiate or conduct to other components in the system and cause interference. It is essential to keep the power and output traces short and well shielded if possible. Use of ground planes, beads, and micro-strip layout techniques are all useful in preventing unwanted interference.

As the distance from the LM48411 and the speaker increase, the amount of EMI radiation will increase since the output wires or traces acting as antenna become more efficient with length. What is acceptable EMI is highly application specific. Ferrite chip inductors placed close to the LM48411 may be needed to reduce EMI radiation. The value of the ferrite chip is very application specific.

SHUTDOWN FUNCTION

In order to reduce power consumption while not in use, the LM48411 contains shutdown circuitry that reduces current draw to less than 0.01µA. The trigger point for shutdown is shown as a typical value in the Electrical Characteristics Tables and in the Shutdown Hysteresis Voltage graphs found in the **Typical Performance Characteristics** section. It is best to switch between ground and supply for minimum current usage while in the shutdown state. While the LM48411 may be disabled with shutdown voltages in between ground and supply, the idle current will be greater than the typical 0.01µA value.

The LM48411 has an internal resistor connected between GND and Shutdown pins. The purpose of this resistor is to eliminate any unwanted state changes when the Shutdown pin is floating. The LM48411 will enter the shutdown state when the Shutdown pin is left floating or if not floating, when the shutdown voltage has crossed the threshold. To minimize the supply current while in the shutdown state, the Shutdown pin should be driven to GND or left floating. If the Shutdown pin is not driven to GND, the amount of additional resistor current due to the internal shutdown resistor can be found by Equation (1) below.

$$(V_{SD} - GND) / 300k\Omega \quad (1)$$

With only a 0.5V difference, an additional 1.7µA of current will be drawn while in the shutdown state.

AUDIO AMPLIFIER POWER SUPPLY BYPASSING FILTERING

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitor as close to the device as possible. Typical applications employ a voltage regulator with 10µF and 0.1µF bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM48411 supply pins. A 1µF capacitor is recommended.

Build of Materials

| Designator | Description | Footprint | Quantity |
|---------------|--|-----------|----------|
| C1, C2 | Ceramic Capacitor 0.1µF, 50V, 10% | 805 | 2 |
| C3 – C6 | Tantalum Capacitors 1µF 20V, 10%, Size A | 1206 | 4 |
| C11 | Tantalum Capacitors 10µF 20V, 10% Size B | 1411 | 1 |
| JP1–5, JP8–11 | Jumper Header Vertical Mount 2X1 0.100 | | 9 |
| JP6, JP7 | Jumper Header Vertical Mount 3x1 0.100 | | 2 |

AUDIO AMPLIFIER INPUT CAPACITOR SELECTION

Input capacitors may be required for some applications, or when the audio source is single-ended. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM48411. The input capacitors create a high-pass filter with the input resistance R_i . The -3dB point of the high pass filter is found using Equation 1 below.

$$f = 1 / 2\pi R_i C_i \quad (2)$$

The values for R_i can be found in the EC table for each gain setting.

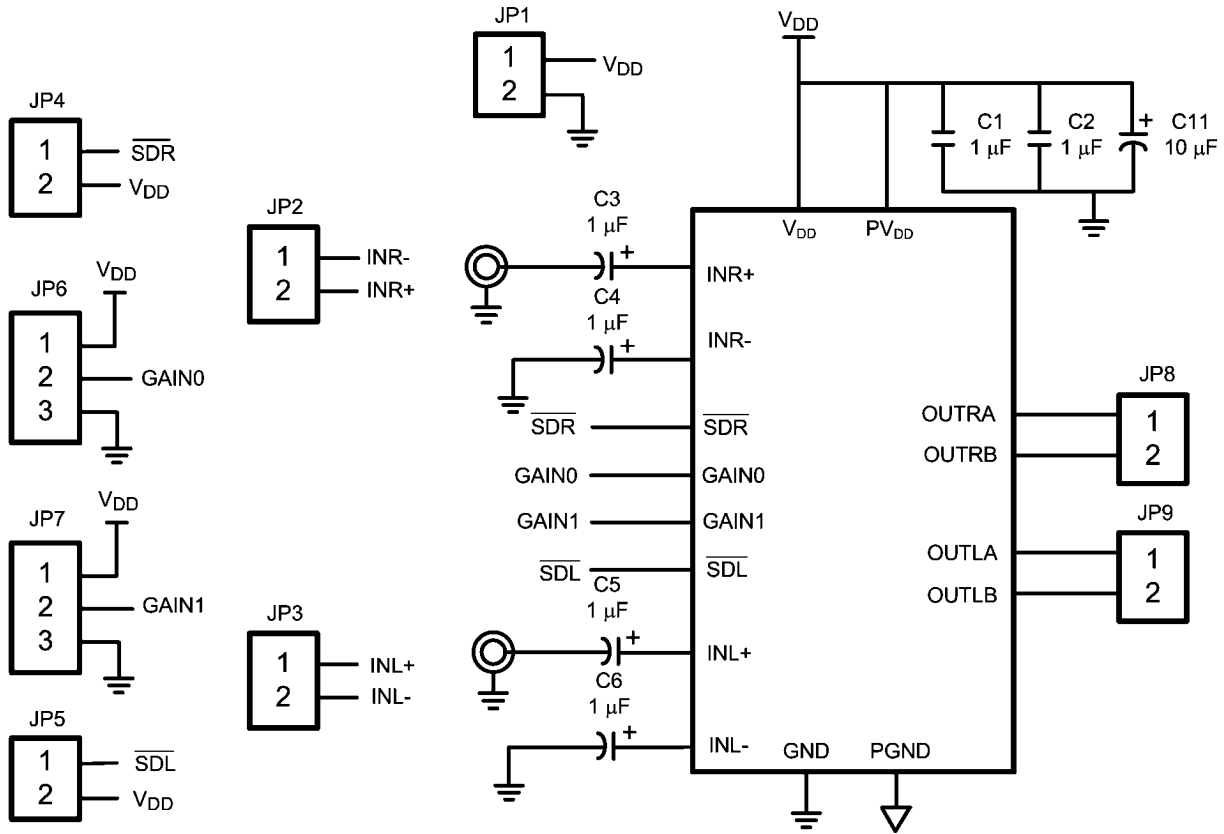
The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High pass filtering the audio signal helps protect the speakers. When the LM48411 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217 Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

AUDIO AMPLIFIER GAIN SETTING

The LM48411 features four internally configured gain settings. The device gain is selected through the two logic inputs, G0 and G1. The gain settings are as shown in the following table.

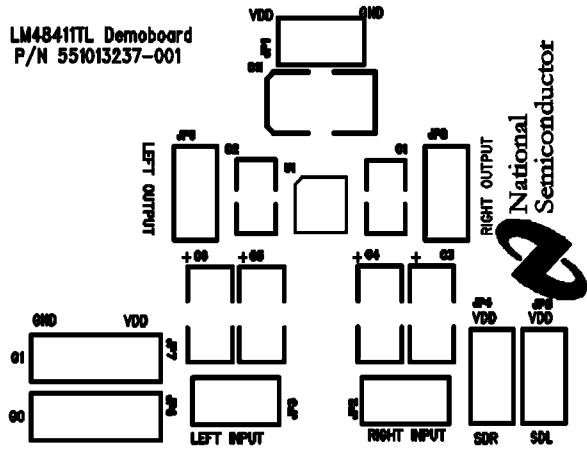
| LOGIC INPUT | | GAIN | |
|-------------|----|------|----|
| G1 | G0 | V/V | dB |
| 0 | 0 | 2 | 6 |
| 0 | 1 | 4 | 12 |
| 1 | 0 | 8 | 18 |
| 1 | 1 | 16 | 24 |

Demonstration Board Schematic



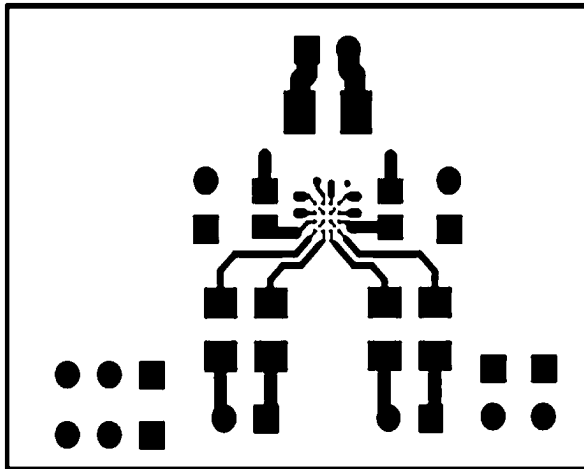
30009592

Demonstration Board Layout



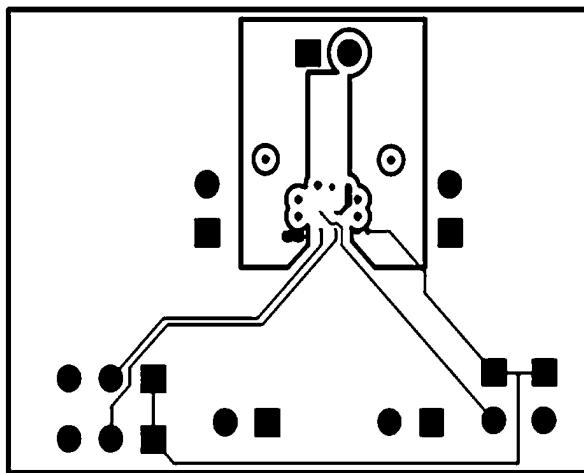
Top Silkscreen Layer

30009591



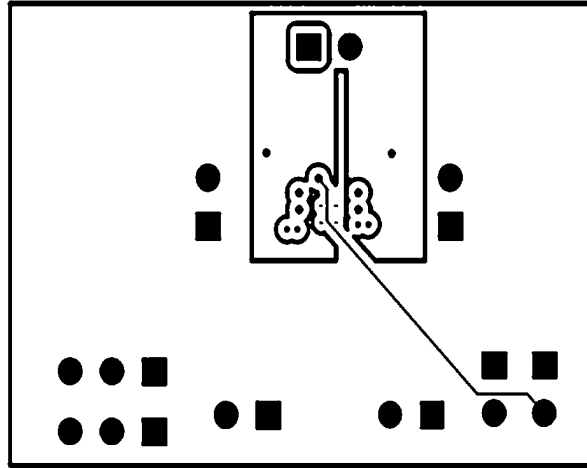
Top Layer

30009590



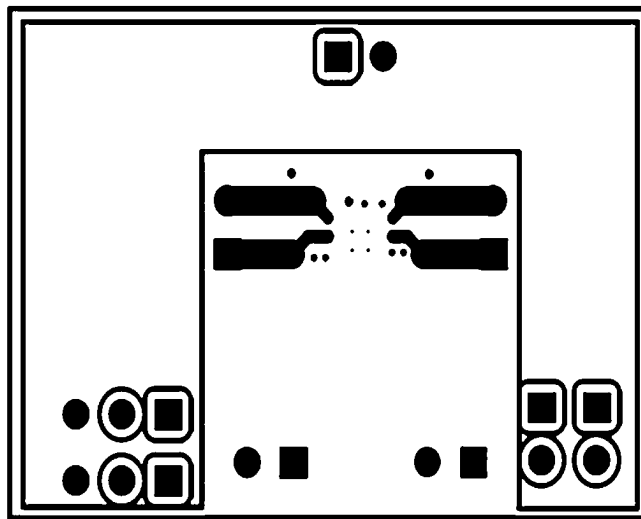
Mid 1 Layer

30009588



Mid 2 Layer

30009589



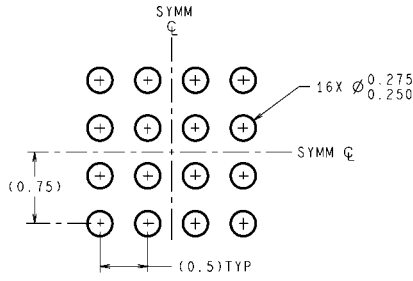
Bottom Layer

30009587

Revision History

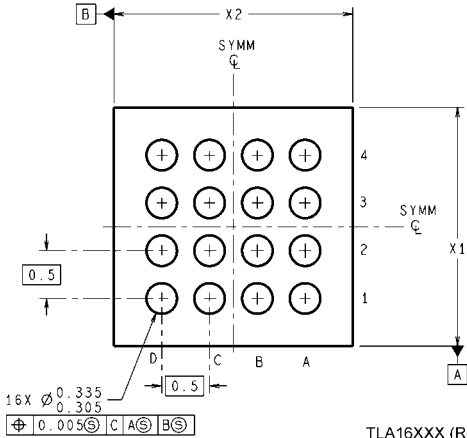
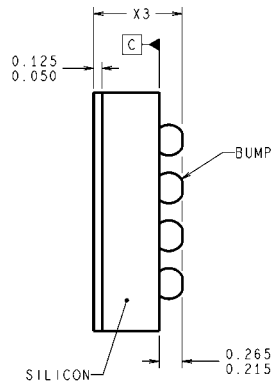
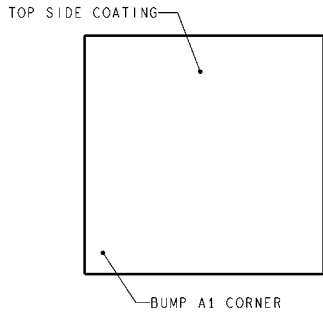
| Rev | Date | Description |
|-----|----------|---|
| 1.0 | 09/21/07 | Initial release. |
| 1.1 | 10/01/07 | Fixed few typos. |
| 1.2 | 11/30/07 | Added the demo boards and BOM. |
| 1.3 | 12/19/07 | Edited the 16-bump micro SMD package diagram and the Pin Description table. |
| 1.4 | 01/08/08 | Edited the 16-bump micro SMD package diagram. |
| 1.5 | 06/27/08 | Text edits. |
| 1.6 | 07/03/08 | Text edits (under SHUTDOWN FUNCTION). |

Physical Dimensions inches (millimeters) unless otherwise noted



DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN () FOR REFERENCE ONLY

LAND PATTERN RECOMMENDATION



TLA16XXX (Rev C)

16 Bump micro SMD
Order Number LM48411TL
NS Package Number TLA16ACA
X1 = 1.996mm X2 = 2.047mm X3 = 0.6mm

Notes

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